

HSF Compliant

REV.	ECN NO.	DESCRIPTION	DRAW	CHECK	APPD.	DATE
X0	—	新版发行	YIN	BENDEE	BENDEE	2021.08.05

MATERIALS

- 1.HOUSING:LCP, (UL 94V-0), BLACK
- 2.TERMINAL:BRASS (C2680),
GOLD PLATING 15u" Min. ON CONTACT AREA,
MATTE TIN 80u" Min. PLATING ON SOLDER TAIL,
UNDER NICKEL PLATING 50u" Min OVER ALL.
- 3.SHELL:Stainless Steel, NICKEL PLATING 30u" Min.
- 4.CAP:LCP, (UL 94V-0), BLACK

SPECIFICATION

- 1.CURRENT RATING : 0.5 A MAX.
- 2.DIELECTRIC WITHSTANDING VOLTAGE : 500V AC R.M.S.
FOR ONE MINUTE.
- 3.INSULATION RESISTANCE : 100M OHMS MIN.
4. CONTACT RESISTANCE : 30m OHMS MAX.
5. OPERATING TEMPERATURE : -20°C TO +85°C.
6. INSERTION FORCE : 4.5kgf MAX.
7. EXTRACTION FORCE : 1.0~4.0kgf MIN.
8. SALT SPRAY : 48 HOURS PASS.
9. REFLOW SOLDERING(SMD COMPONENT) OVEN
- 10.TEMPERATURE:260°C.5SEC

料号备注

R=PACK-TXXXX

CP 0 F 017 M XX X XX X X

12=半金雾锡10u"
13=半金雾锡30u"
14=半金雾锡50u"
15=半金雾锡150u"
16=半金雾锡300u"

00=LCP黑不锈钢壳镀镍

R=ROHS2.0标准
W=无卤+ROHS2.0
H=REACH标准

B=盐雾24H
C=盐雾48H



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UNLESS OTHERWISE SPECIFIED TOLERANCES		APPROVAL	日期	品名规格	DISPLAY PORT SMT直立式H15.0mm (无弹)	
.X	+/-	制图	YIN	2021.08.05	料号	SEE TABLE
.XX	+/-	审核				
.XXX	+/-	核准				
FRACTIONS	+/-	文件位置		字张	工程图号:	版本.
ANGLES	+/-	2.00°		ANGLED OF PROJECTION	DWG-CPAF-017	X0
DIMENSIONS						
(METRIC)	(MM)			比例	1 : 1	状态码 A
				页数	1	OF 1